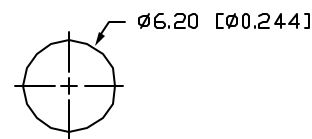


PANEL CUTOUT



NOTES:

1. SSL-LX3054SR, RED LED. TRIM LEADS TO 5mm.
2. SSI-LXR1612, CHROME HOUSING.
3. LXP-WA-3612, RUBBER GASKET.
4. SOLDER WIRE TO LEADS.
5. SSH-LXH1612BSG, BUSHING, INSERT AND CRIMP.
6. ANODE: 26 AWG, STRANDED, RED INSULATION. CUT 157mm LONG, STRIP ENDS 2mm & 9.5mm.
7. CATHODE: 26 AWG, STRANDED, BLACK INSULATION. CUT 157mm, STRIP ENDS 2mm & 9.5mm.
8. ASSEMBLE IN ORDER: LED, SILICON, THEN BUSHING.
9. WATER RESISTANT PER NEMA STANDARD 250 SECT. 6.7.

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^{\circ}\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		660		nm	
FORWARD VOLTAGE		1.7	2.2	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_f=100\mu\text{A}$
AXIAL INTENSITY		70		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	RED DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.6	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX

* $t < 10\mu\text{s}$

*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN= $\frac{+0.00}{-0.00}$ DECIMAL PRECISION, MAX= $\frac{+0.00}{-0.00}$ DECIMAL PRECISION

REV.

PART NUMBER

SSI-LXR1612SR150WR

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T-3mm (T-1) 660nm RED LED PANEL INDICATOR,
RED DIFFUSED LENS, 6" WIRE LEADS, WATER RESISTANT.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: JD	CHECKED BY:	APPROVED BY:	DATE: 11.05.05
			PAGE: 1 OF 1
			SCALE: N/A